

**CLAIM AMENDMENTS**

1. (Currently amended) A tamper evident RFID tag, comprising:  
a tamper evident label material, with  
an adhesive on a back side, and  
an RFID Transponder adhered to said adhesive, wherein:  
the tamper evident label material is a vinyl with a tensile and tear resistance such that the tamper evident label material one of tears and breaks upon an attempted removal from a substrate.

2. (Cancelled)

3. (Original) The tag of claim 1, wherein:  
the tamper evident label material is 3M 7610 ScotchMark Destructible Vinyl.

4. (Original) The tag of claim 1, further including:  
a release liner attached to said adhesive.

5. (Original) The tag of claim 1, further including:  
a hologram on the label material.

6. (Original) The tag of claim 1, further including:  
microprinting on the label material.

7. (Currently amended) A tamper evident RFID tag, comprising  
a clear label material, with  
a silicone pattern and an a pigmented adhesive on a back side, and  
an RF transponder adhered to said adhesive;  
wherein separation of the tag from a substrate results in incomplete separation of  
the adhesive in the form of the silicone pattern and said pattern becomes visible.

8. (Original) The tag of claim 7, wherein:  
the tamper evident label material is one of 3M 7866, 3M 7389 and 3M 7385.

9. (Original) The tag of claim 8, further including:  
a hologram on the label material.

10. (Currently amended) The tag of claim 9 8, further including:  
microprinting on the label material.

11. (Currently amended) A tamper evident RF transponder, comprising  
a base film with a printed antenna and an integrated circuit chip on a front surface;  
the base film having ~~propagation~~ tear cuts at one or more edges of the base film  
whereby attempted removal of the RF transponder from a substrate causes the ~~propagation~~  
tear cuts to expand and to sever a connection between the printed antenna and the  
integrated circuit chip.

12. (Cancelled)

13. (Currently amended) The method of claim ~~12~~ 21, further including the step of:  
applying a release liner to the adhesive.

14. (New) The tag of claim 3, further including:  
a release liner attached to said adhesive.

15. (New) The tag of claim 3, further including:  
a hologram on the label material.

16. (New) The tag of claim 3, further including:  
microprinting on the label material.

17. (New) The tag of claim 8, further including:  
a release liner attached to said adhesive.

18. (New) The tag of claim 7, further including:  
a release liner attached to said adhesive.

A  
Cmt.  
WJ

INTERMEC IP CORP.  
Serial Number: 10/092174  
Page 4 of 8  
October 1, 2003

19. (New) The tag of claim 7, further including:  
a hologram on the label material.

20. (New) The tag of claim 7, further including:  
microprinting on the label material.

21. (New) A method of fabricating a tamper evident RFID tag, comprising the steps of:  
embedding the RFID transponder of claim 11 into a label material, and applying an  
adhesive to a backside of the label material.

---

*1) contd.*